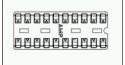
1825373 - 6 Product Details



1825373 -6

DIP Sockets

Home > Products > By Type > Socket/Card Products __ > Product Feature Selector __ > Product Details

Always EU RoHS/ELV Compliant (Statement of Compliance

Product Highlights:

- ? DIP Socket
- Number of Positions = 20
- ? Row-to-Row Spacing = 7.87 mm
- ? Thru Hole
 - Mount Style = Vertical

<u>View all Features</u> | <u>Find Similar</u> <u>Products</u> Live Product Chat US Only 8:30am - 5pm ET, Mon - Fri

Quick Links

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Product Feature
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This Product

Documentation & Additional Information

Product Drawings:

DIP SOCKET ASSY, CLOSED, DIPLOMATE, RETENTIVE LEAD, ...
(PDF, English)

Catalog Pages/Data Sheets:

? None Available

Product Specifications:

? None Available

Application Specifications:

DIPLOMATE DL (Dual Leaf) DIP Sockets (PDF, English)

Instruction Sheets:

? None Available

CAD Files:

? None Available

Additional Information:

? Product Line Information

Related Products:

? Tooling

List all Documents

Product Features

(Please use the Product Drawing for all design activity)

Product Type Features:

- ? Product Type = DIP Socket
- Number of Positions = 20
- ? Profile = Standard
- ? Frame Style = Closed
- ? <u>Leg Style</u> = Retention
- ? Proprietary Name = DIPLOMATE DL
- ? Color = Black
- ? Qty./Tube = 17
- 2 Qty. Tubes/Box = 100
- Product Series = Standard
- ? Comment = ONLY sockets with straight solder tails are recommended for automatic insertion.

Electrical Characteristics:

- ? Insulation Resistance (M?) = 10,000
- ? Contact Resistance (m?) = 30

Termination Related Features:

- ? Termination (Solder) Post Length (mm [in]) = 3.05 [0.120]
- ? Solder Tail Contact Plating = Tin

Body Related Features:

- ? Row-to-Row Spacing (mm [in]) = 7.87 [0.310]
- ? Mount Style = Vertical
- ? Centerline (mm [in]) = 2.54 [0.100]

Contact Related Features:

- ? Contact Mount = Thru Hole
- Contact Material = Phosphor Bronze
- ? Contact Mating Area Plating = Gold (15)
- ? Contact Style = Stamped + Formed
- Mating Contact Type = Dual Leaf

Housing Related Features:

- Housing Material = Thermoplastic Glass reinforced
- Programma Progra

Configuration Related Features:

Height Above PC Board (mm [in]) = 5.33 [0.210]

Industry Standards:

- ? RoHS/ELV Compliance = RoHS compliant, ELV compliant
- Lead Free Solder Processes = Wave solder capable to 240°C, Wave solder capable to 260° C, Wave solder capable to 265°C
- ? RoHS/ELV Compliance History = Always was RoHS compliant

Conditions for Usage:

? Temperature Range (°C) = 125

Operation/Application:

? Application = Production

Packaging Related Features:

? Packaging Method = Tube

Other

? Brand = Tyco Electronics